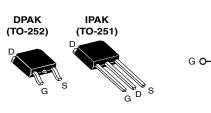
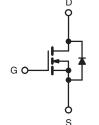


Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	60				
R _{DS(on)} (Ω)	V _{GS} = 10 V 0.20				
Q _g (Max.) (nC)	11				
Q _{gs} (nC)	3.1				
Q _{gd} (nC)	5.8				
Configuration	Sing	le			





N-Channel MOSFET

FEATURES

- Dynamic dV/dt Rating
- Surface Mount (IRFR014, SiHFR014)
- Straight Lead (IRFU014, SiHFU014)
- Available in Tape and Reel
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements



- And Reel HALOGEN
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The DPAK is designed for surface mounting using vapor phase, infrared, or wave soldering techniques. The straight lead version (IRFU, SiHFU series) is for through-hole mounting applications. Power dissipation levels up to 1.5 W are possible in typical surface mount applications.

ORDERING INFORMATION						
Package	DPAK (TO-252)	DPAK (TO-252)	DPAK (TO-252)	IPAK (TO-251)		
Lead (Pb)-free and Halogen-free	SiHFR014-GE3	SiHFR014TRL-GE3	SiHFR014TR-GE3	SIHFU014-GE3		
Lood (Db) free	IRFR014PbF	IRFR014TRLPbF ^a	IRFR014TRPbFa	IRFU014PbF		
Lead (Pb)-free	SiHFR014-E3	SiHFR014TL-E3 ^a	SiHFR014T-E3a	SiHFU014-E3		

Note

a. See device orientation.

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V _{DS}	60	- V
Gate-Source Voltage			V _{GS}	± 20	v
Continuous Drain Current	$T_C = 25 \text{ °C}$ $T_C = 100 \text{ °C}$	1	7.7		
Continuous Drain Current	I _D	4.9	А		
Pulsed Drain Current ^a	I _{DM}	31			
Linear Derating Factor		0.20	W/°C		
Linear Derating Factor (PCB Mount) ^e				0.020	W/ C
Single Pulse Avalanche Energy ^b			E _{AS}	27.4	mJ
Maximum Power Dissipation	D	25	W		
Maximum Power Dissipation (PCB Mount) ^e	P _D	2.5	~~~		
Peak Diode Recovery dV/dtc	dV/dt	4.5	V/ns		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature) ^d	for	10 s		260	-0

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

- b. V_{DD} = 25 V, starting T_J = 25 °C, L = 924 µH, R_g = 25 Ω , I_{AS} = 7.7 A (see fig. 12).
- c. $I_{SD} \le 10$ A, dl/dt ≤ 90 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C.

d. 1.6 mm from case.

e. When mounted on 1" square PCB (FR-4 or G-10 material).



THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	-	110		
Maximum Junction-to-Ambient (PCB Mount) ^a	R _{thJA}	-	-	50	°C/W	
Maximum Junction-to-Case (Drain)	R _{thJC}	-	-	5.0		

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static		·					•
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	60	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Referenc	e to 25 °C, I _D = 1 mA	-	0.068	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	- V _{GS} , I _D = 250 μΑ	2.0	-	4.0	V
Gate-Source Leakage	I _{GSS}	,	$V_{GS} = \pm 20 V$	-	-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}		= 60 V, V _{GS} = 0 V	-	-	25	μA
	200		V _{GS} = 0 V, T _J = 125 °C	-	-	250	ſ
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$	$I_D = 4.6 A^b$	-	-	0.20	Ω
Forward Transconductance	9 _{fs}	V _{DS} :	= 25 V, I _D = 4.6 A	2.4	-	-	S
Dynamic		_			-	-	
Input Capacitance	Ciss		$V_{GS} = 0 V$,	-	300	-	
Output Capacitance	C _{oss}]	$V_{DS} = 25 V$,	-	160	-	pF
Reverse Transfer Capacitance	C _{rss}	f = 1.	0 MHz, see fig. 5	-	29	-	
Total Gate Charge	Qg			-	-	11	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$	$I_D = 10 \text{ A}, V_{DS} = 48 \text{ V},$ see fig. 6 and 13 ^b	-	-	3.1	nC
Gate-Drain Charge	Q _{gd}	1		-	-	5.8	
Turn-On Delay Time	t _{d(on)}			-	10	-	
Rise Time	t _r	V _{DD} :	= 30 V, I _D = 10 A,	-	50	-	
Turn-Off Delay Time	t _{d(off)}	$R_g = 24 \Omega$,	$R_D = 2.7 \Omega$, see fig. 10^{b}	-	13	-	ns
Fall Time	t _f	1		-	19	-	
Internal Drain Inductance	L _D	Between lead 6 mm (0.25") 1	from	-	4.5	-	nH
Internal Source Inductance	L _S	package and die contact ^c	center of	-	7.5	-	
Drain-Source Body Diode Characteristic	S						
Continuous Source-Drain Diode Current	I _S	MOSFET sym showing the	bol	-	-	7.7	A
Pulsed Diode Forward Current ^a	I _{SM}	integral revers p - n junction	÷ ===/	-	-	31	
Body Diode Voltage	V_{SD}	T _J = 25 °C	, $I_{\rm S}$ = 7.7 A, $V_{\rm GS}$ = 0 V ^b	-	-	1.6	V
Body Diode Reverse Recovery Time	t _{rr}	T _ 05 °O L	- 10 A dl/dt 100 A/a-b	-	70	140	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$I_{\rm J} = 25 {}^{-}{\rm C}, I_{\rm F}$	= 10 A, dl/dt = 100 A/µs ^b	-	0.20	0.40	μC
Forward Turn-On Time	t _{on}	Intrinsic tu	rn-on time is negligible (turn	-on is dor	ninated b	v Ls and	Ln)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width $\leq 300~\mu s;$ duty cycle $\leq 2~\%.$



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

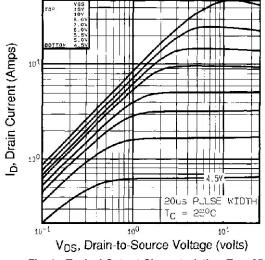


Fig. 1 - Typical Output Characteristics, $T_C = 25 \ ^{\circ}C$

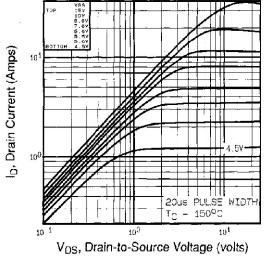


Fig. 2 - Typical Output Characteristics, T_C = 150 °C

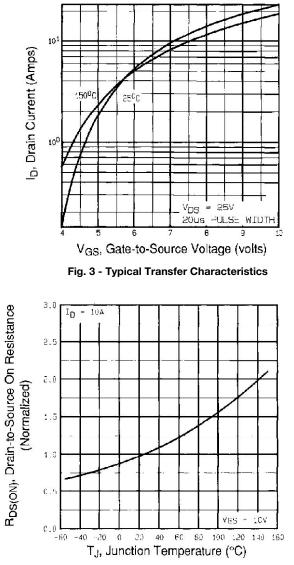


Fig. 4 - Normalized On-Resistance vs. Temperature

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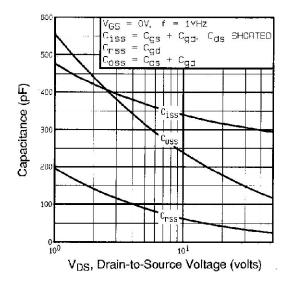
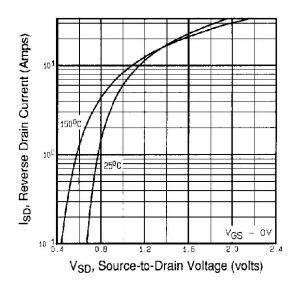
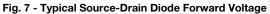


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





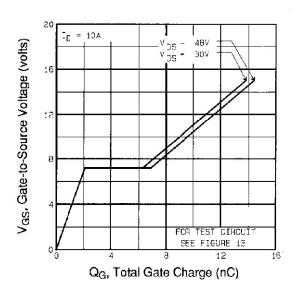


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

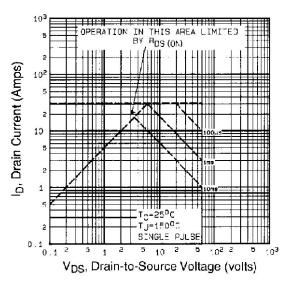


Fig. 8 - Maximum Safe Operating Area



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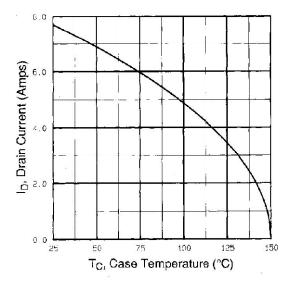


Fig. 9 - Maximum Drain Current vs. Case Temperature

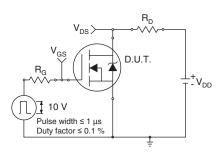


Fig. 10a - Switching Time Test Circuit

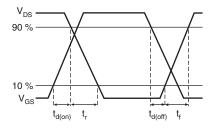


Fig. 10b - Switching Time Waveforms

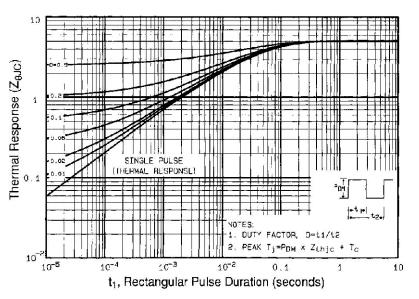


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



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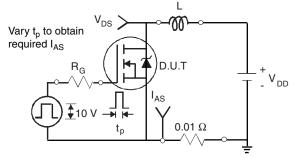


Fig. 12a - Unclamped Inductive Test Circuit

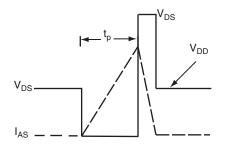


Fig. 12b - Unclamped Inductive Waveforms

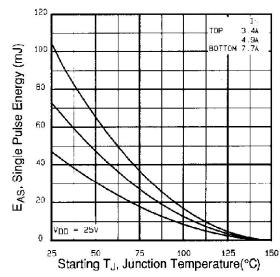


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

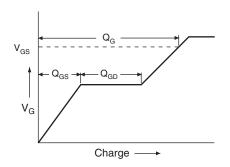
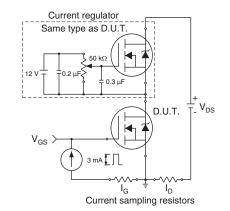


Fig. 13a - Basic Gate Charge Waveform



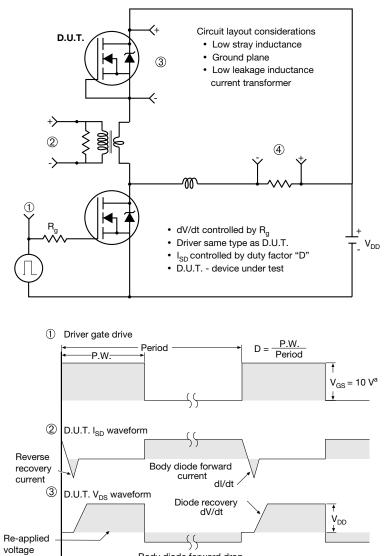


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Peak Diode Recovery dV/dt Test Circuit



Inductor current

Note

4

a. $V_{GS} = 5$ V for logic level devices

Fig. 14 - For N-Channel

 I_{SD}

Body diode forward drop

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TO-252AA Case Outline

VERSION 1: FACILITY CODE = Y







	MILLIMETERS			
DIM.	MIN.	MAX.		
А	2.18	2.38		
A1	-	0.127		
b	0.64	0.88		
b2	0.76	1.14		
b3	4.95	5.46		
С	0.46	0.61		
C2	0.46	0.89		
D	5.97	6.22		
D1	4.10	-		
E	6.35	6.73		
E1	4.32	-		
Н	9.40	10.41		
е	2.28	BSC		
e1	4.56	BSC		
L	1.40	1.78		
L3	0.89	1.27		
L4	-	1.02		
L5	1.01	1.52		

Note

• Dimension L3 is for reference only



VERSION 2: FACILITY CODE = N



	MILLIMETERS				
DIM.	MIN.	MAX.			
A	2.18	2.39			
A1	-	0.13			
b	0.65	0.89			
b1	0.64	0.79			
b2	0.76	1.13			
b3	4.95	5.46			
С	0.46	0.61			
c1	0.41	0.56			
c2	0.46	0.60			
D	5.97	6.22			
D1	5.21	-			
E	6.35	6.73			
E1	4.32	-			
е	2.29	BSC			
Н	9.94	10.34			

	MILLIMETERS				
DIM.	MIN.	MAX.			
L	1.50	1.78			
L1	2.74	l ref.			
L2	0.51	BSC			
L3	0.89	1.27			
L4	-	1.02			
L5	1.14	1.49			
L6	0.65	0.85			
θ	0°	10°			
θ1	0°	15°			
θ2	25°	35°			

Notes

• Dimensioning and tolerance confirm to ASME Y14.5M-1994

• All dimensions are in millimeters. Angles are in degrees

• Heat sink side flash is max. 0.8 mm

Radius on terminal is optional

ECN: E19-0649-Rev. Q, 16-Dec-2019 DWG: 5347



TO-251AA (HIGH VOLTAGE)



	MILLI	METERS	INC	HES		MILLI	METERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.	DIM.	MIN.	MAX.	MIN.	MA
А	2.18	2.39	0.086	0.094	D1	5.21	-	0.205	-
A1	0.89	1.14	0.035	0.045	E	6.35	6.73	0.250	0.2
b	0.64	0.89	0.025	0.035	E1	4.32	-	0.170	-
b1	0.65	0.79	0.026	0.031	е	2.29	BSC	2.29	BSC
b2	0.76	1.14	0.030	0.045	L	8.89	9.65	0.350	0.3
b3	0.76	1.04	0.030	0.041	L1	1.91	2.29	0.075	0.0
b4	4.95	5.46	0.195	0.215	L2	0.89	1.27	0.035	0.0
с	0.46	0.61	0.018	0.024	L3	1.14	1.52	0.045	0.0
c1	0.41	0.56	0.016	0.022	θ1	0'	15'	0'	15
c2	0.46	0.86	0.018	0.034	θ2	25'	35'	25'	35
D	5.97	6.22	0.235	0.245		•	•	•	

Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimension are shown in inches and millimeters.
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.13 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.
- 4. Thermal pad contour optional with dimensions b4, L2, E1 and D1.
- 5. Lead dimension uncontrolled in L3.
- 6. Dimension b1, b3 and c1 apply to base metal only.
- 7. Outline conforms to JEDEC outline TO-251AA.



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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